ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® MAterial Comp © Copyright 2005. 1 international and Par	PC, Bannock	burn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declar the declaration	ration on encor	of the substat mpasses all 1	nces wi ower le	thin the manufa evel materials fo	acturer listed or which the	item. N manufa	Note: if th acturer ha	ne item is an as as engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					aterials and N	lfg Inf	ormation			
Supplier Information																
Company name* Company unio			nique ID Un			Unique ID Authority					Respon	Response Date*				
onsemi											2025-0	2025-09-15				
Contact Name Title - Contact					Phone - Contact*					Email ·	Email - Contact*					
Product-Env-Stewards	Product Envi	roduct Enviro Compliance			NA					Produ	Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Represe			esentative 3			Phone - Representative*				Email ·	Email - Representative*					
Product-Env-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com						
Requester Item Number	em Number Mfr Item Num		Number Mfr Item Name			Effective Date Version Manufacturing Site		e	Weigh	nt*	UOM	Unit Type				
	PCA953	PCA9535EDTR2G 16-BIT I/O EX				2025-09-15			PH	PH1		69.68		mg	Each	
Aanufacturing Proccess Informa	tion					- -	1		I					•	1	
Terminal Plating / Grid Array Ma	aterial '	Terminal Base Alloy		J-STD-020 MS	TD-020 MSL Rating		Peak Process Body		Cemperature Max Time at Peak		Peak Tempera	Temperature Number of Reflow C		of Reflow Cyc	cles	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С		30		nds	3			
comments																
evel 1 - maximum time at peak temperatu	ire during so	ldering is 10-3	0 seconds													
or more information regarding material	composition	please refer to	page 3													

RoHS Material Composition Declaration				Declaration Type *	Detailed								
Directive 2015/863/EU amending RoHS Directive 2011/65/EU													
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of								
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all								
Exemption List Version	EL-2011/534/EU												
Declaration Signature													
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the								
Supplier Digital Signature Ra	stislav Drska	Le											

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or enter [F] Optionally enter the positive (+) ar				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.12	mg	Supplier	Silicon (Si)	7440-21-3		3.12	mg
Die Attach	1.26	mg	Supplier	Silver (Ag)	7440-22-4		0.945	mg
			Supplier	Epoxy resins	129915-35-1		0.315	mg
Lead Frame	16.21	mg	Supplier	Iron (Fe)	7439-89-6		0.308	mg
			Supplier	Copper (Cu)	7440-50-8		15.902	mg
Mold Compound-Black	45.76	mg		Epoxy Phenol Resin	proprietary data		4.8048	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		40.9552	mg
Plating	2.91	mg	Supplier	Palladium (Pd)	7440-05-3		0.2212	mg
			В	Nickel (Ni)	7440-02-0		2.6481	mg
			Supplier	Gold (Au)	7440-57-5		0.0407	mg
Wire Bond - Au	0.42	mg	Supplier	Gold (Au)	7440-57-5		0.42	mg